



- NOTE'S:
1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCH MIN. THK. OVER NICKEL PLATED UNLESS OTHERWISE SPECIFIED PURCHASE ORDER.
 2. FLATNESS METALLIZED PADS ONLY.
 3. LEAD TO LEAD LEAKAGE MUST NOT EXCEED 5 NANO AMPS AT 100V D.C.
 4. DIE ATTACH PAD SHALL BE ISOLATED FROM ANY LEADS. (ZERO GROUND)

LCC03604 S-0
D-0
A00-360

CHANGE	DATE	DRAWN	CHECKED	APPROVED	NAME	1A00-36C1	TOLERANCES:	DRAWN	CHECKED
					36 LCC		± 1 %	<i>Mitsunide</i>	<i>[Signature]</i>
					SCALE	MATERIAL	N.L.T. ±013	APPROVED	DATE
					10/1	KYOCERA A-473			83-6-22
					KYOCERA CORPORATION	KYOTO JAPAN	DWG. #	PB-34226	